

ABSTRACT

A process for curing a natural or synthetic rubber includes the measuring of curing conditions by dielectric or impedance means to produce a process curve (impedance property data versus time) followed by analyzing the process curve with a software
5 algorithm which defines and statistically quantifies the correlation between the process curve and the desired part properties. The correlation relationship is applied in real time to end the curing process at the optimum time and to produce rubber parts of uniform quality and with reduced process cycle time.

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